Yifeng Ding



Research Interests

My research interest lies in Large Language Models (LLMs) for Software Engineering. Currently, I focus on using LLMs to improve automated debugging techniques, including Automated Program Repair (APR) and Fault Localization (FL). One of my recent LLM4APR works, FitRepair [2], has been published in ASE'23.

My ongoing works include using self-instruct and parameter-efficient fine-tuning to improve LLM's instruction-following ability to perform automated debugging, and augmenting LLMs with *information retrieval* techniques for **project-level debugging** tasks.

Education

Since 2022 University of Illinois at Urbana-Champaign (UIUC),

Ph.D. student in Computer Science,

Advisor: Prof. Lingming Zhang

2018–2022 Tsinghua University,

B.S. in Software Engineering,

Double Major: B.S. in Business Administration

Publications

- [1] Yuxiang Wei, Zhe Wang, Jiawei Liu, **Yifeng Ding**, and Lingming Zhang. "Magicoder: Source Code Is All You Need". In: Arxiv. [preprint].
- [2] Chunqiu Steven Xia, **Yifeng Ding**, and Lingming Zhang. "The Plastic Surgery Hypothesis in the Era of Large Language Models". In: 38th IEEE/ACM International Conference on Automated Software Engineering (ASE 2023). [paper].
- [3] Quan Zhang, Yongqiang Tian, Yifeng Ding, Shanshan Li, Chengnian Sun, Yu Jiang, and Jiaguang Sun. "CoopHance: Cooperative Enhancement for Robustness of Deep Learning Systems". In: 32nd ACM SIGSOFT International Symposium on Software Testing and Analysis (ISSTA 2023). [paper].
- [4] Quan Zhang, Yifeng Ding, Yongqiang Tian, Jianmin Guo, Min Yuan, and Yu Jiang. "AdvDoor: Adversarial Backdoor Attack of Deep Learning System". In: 30th ACM SIGSOFT International Symposium on Software Testing and Analysis (ISSTA 2021). [paper].

Academic Service

Committee co-located with ICSE 2024

Organizing The First International Workshop on Large Language Models for Code (LLM4Code 2024),

Talk

[1] Uber Programming Systems Team: Equipping Large Language Models with Domain-Specific Knowledge for Automated Program Repair

Honors & Awards

- 2021 Research Excellence Scholarship, Tsinghua University
- 2019 Academic Excellence Scholarship, Tsinghua University